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(12) **United States Design Patent**  
**Ueda**

(10) **Patent No.:** **US D583,395 S**  
(45) **Date of Patent:** **\*\* Dec. 23, 2008**

(54) **COVER FOR A HEATER STAGE OF A PLASMA PROCESSING APPARATUS**

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(73) Assignee: **Tokyo Electron Limited**, Tokyo (JP)

(\*\*) Term: **14 Years**

(21) Appl. No.: **29/281,073**

(22) Filed: **Jun. 14, 2007**

(30) **Foreign Application Priority Data**

Dec. 15, 2006 (JP) ..... 2006-034517

(51) **LOC (8) Cl.** ..... **15-09**

(52) **U.S. Cl.** ..... **D15/138; D15/199**

(58) **Field of Classification Search** ..... None  
See application file for complete search history.

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(57) **CLAIM**

The ornamental design for a cover for a heater stage of a plasma processing apparatus, as shown.

**DESCRIPTION**

FIG. 1 is a front view of a cover for a heater stage of a plasma processing apparatus showing my new design:

FIG. 2 is a rear view thereof;

FIG. 3 is a right side view thereof;

FIG. 4 is a top plan view thereof;

FIG. 5 is a sectional view taken along line 5—5 of FIG. 1 thereof;

FIG. 6 is an enlarged view taken along line 6—6 of FIG. 5 thereof;

FIG. 7 is an enlarged view taken along line 7—7 of FIG. 5 thereof; and,

FIG. 8 is a perspective view thereof.

**1 Claim, 3 Drawing Sheets**

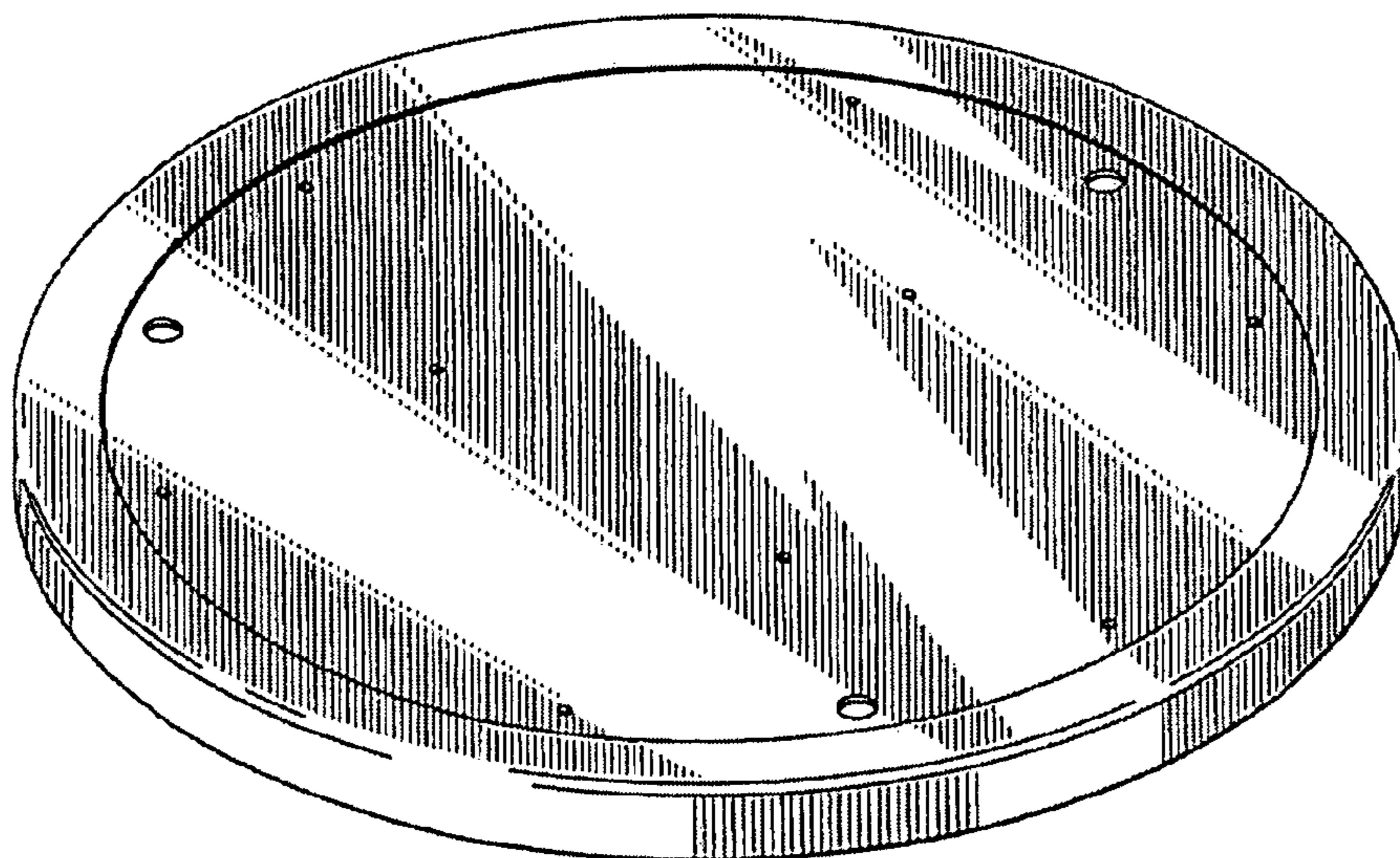


FIG.1

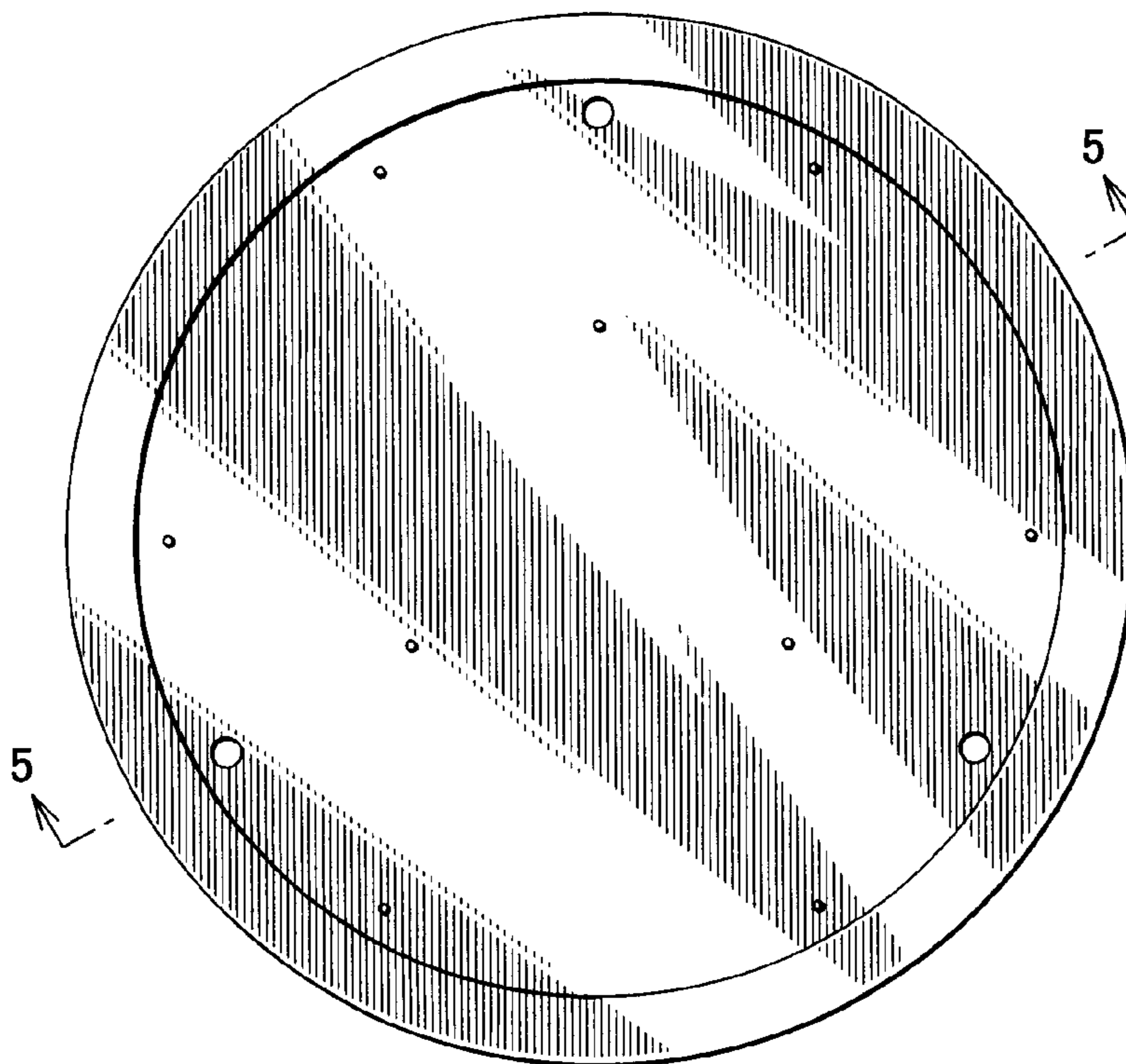


FIG.2

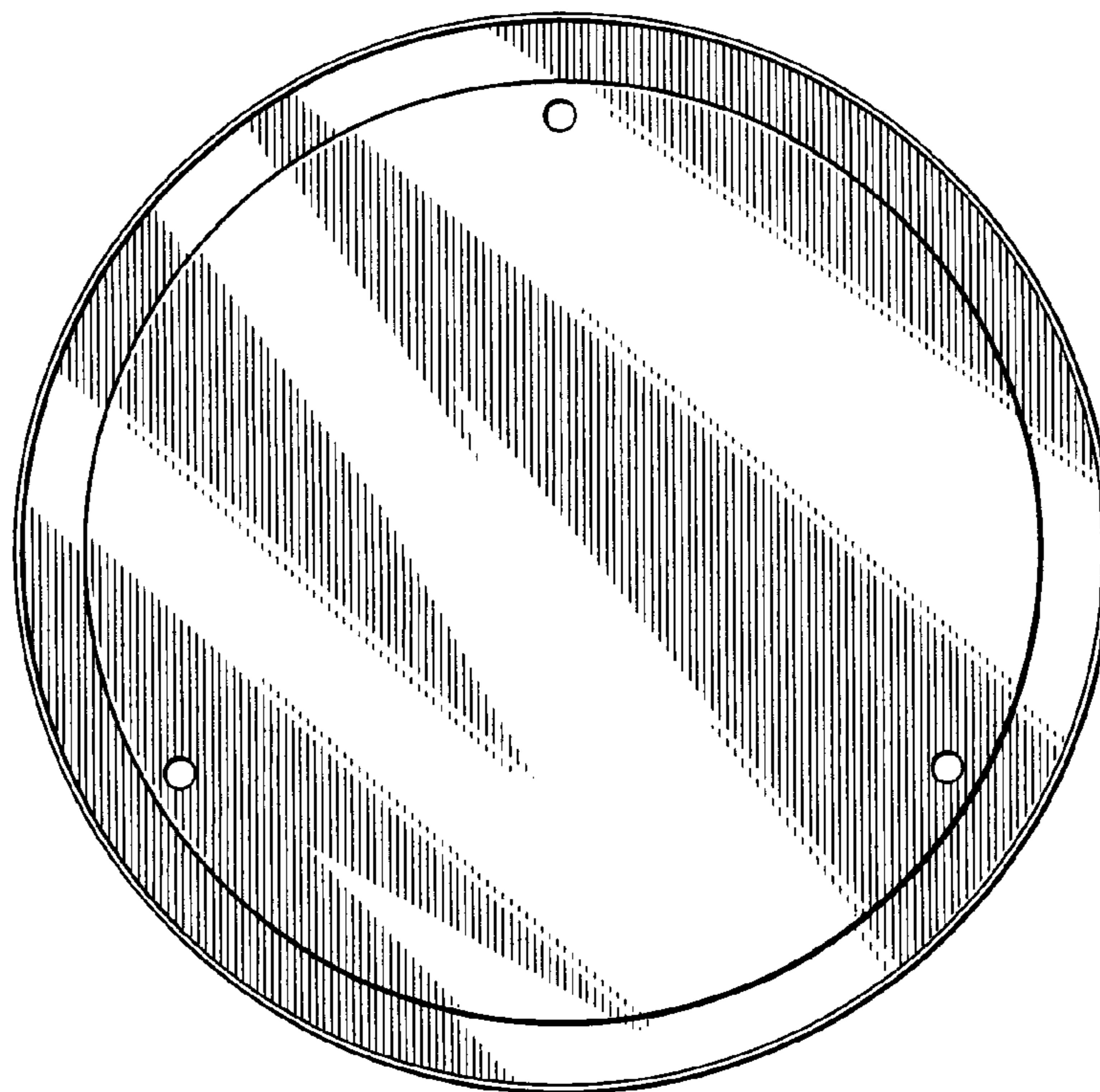


FIG.3



FIG.4



FIG.5

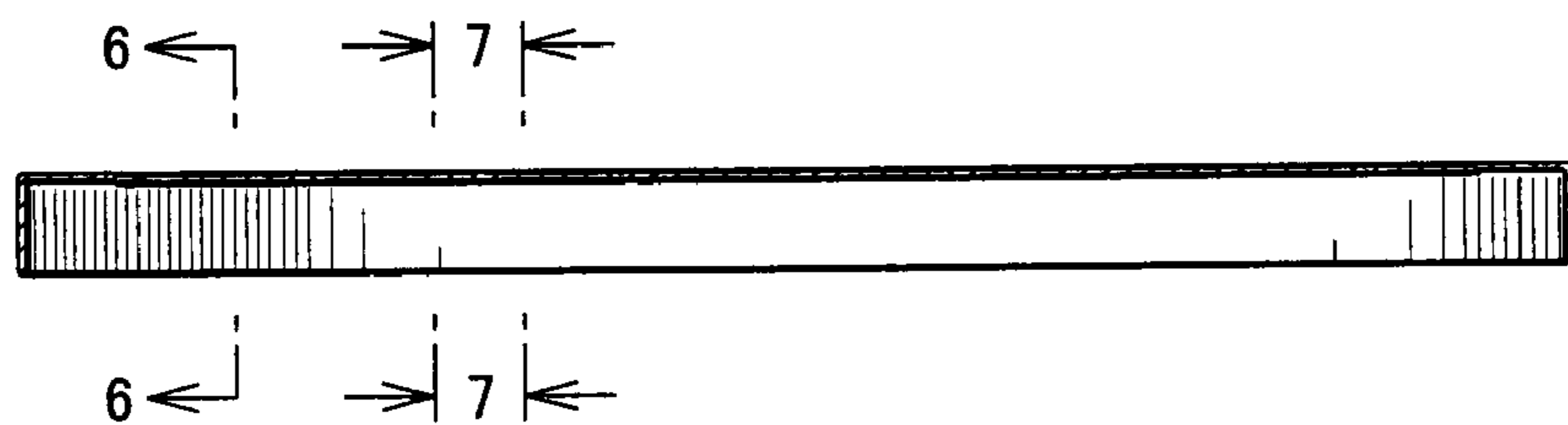


FIG.6

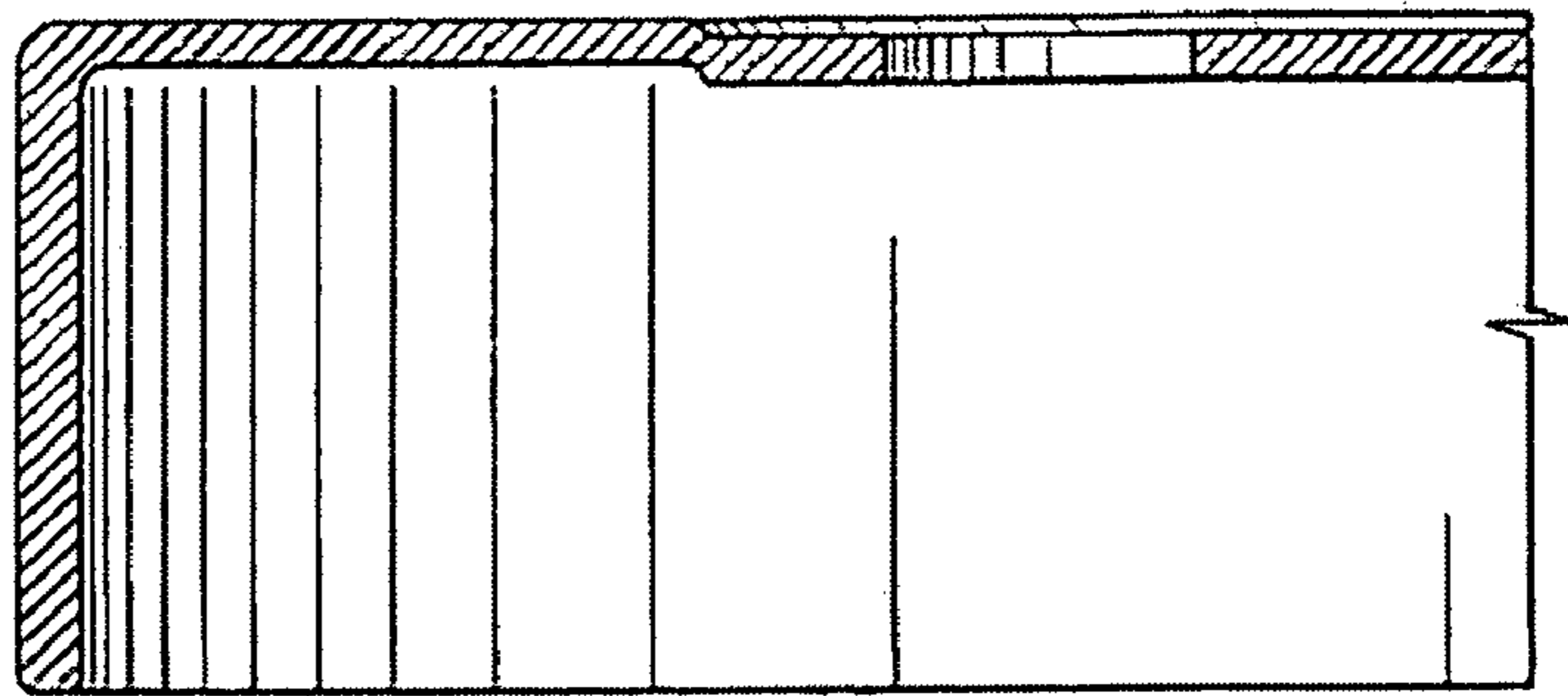


FIG.7

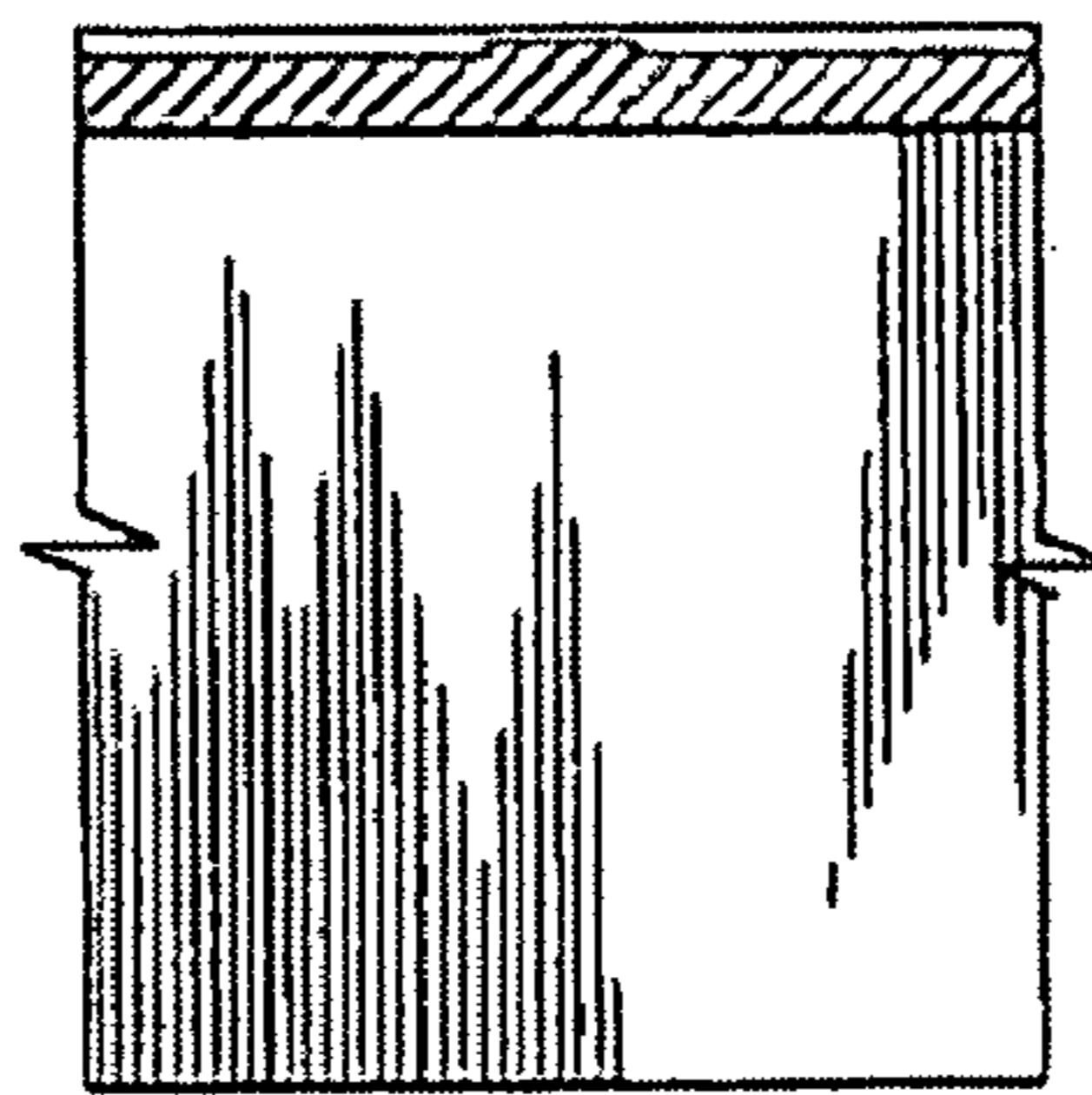
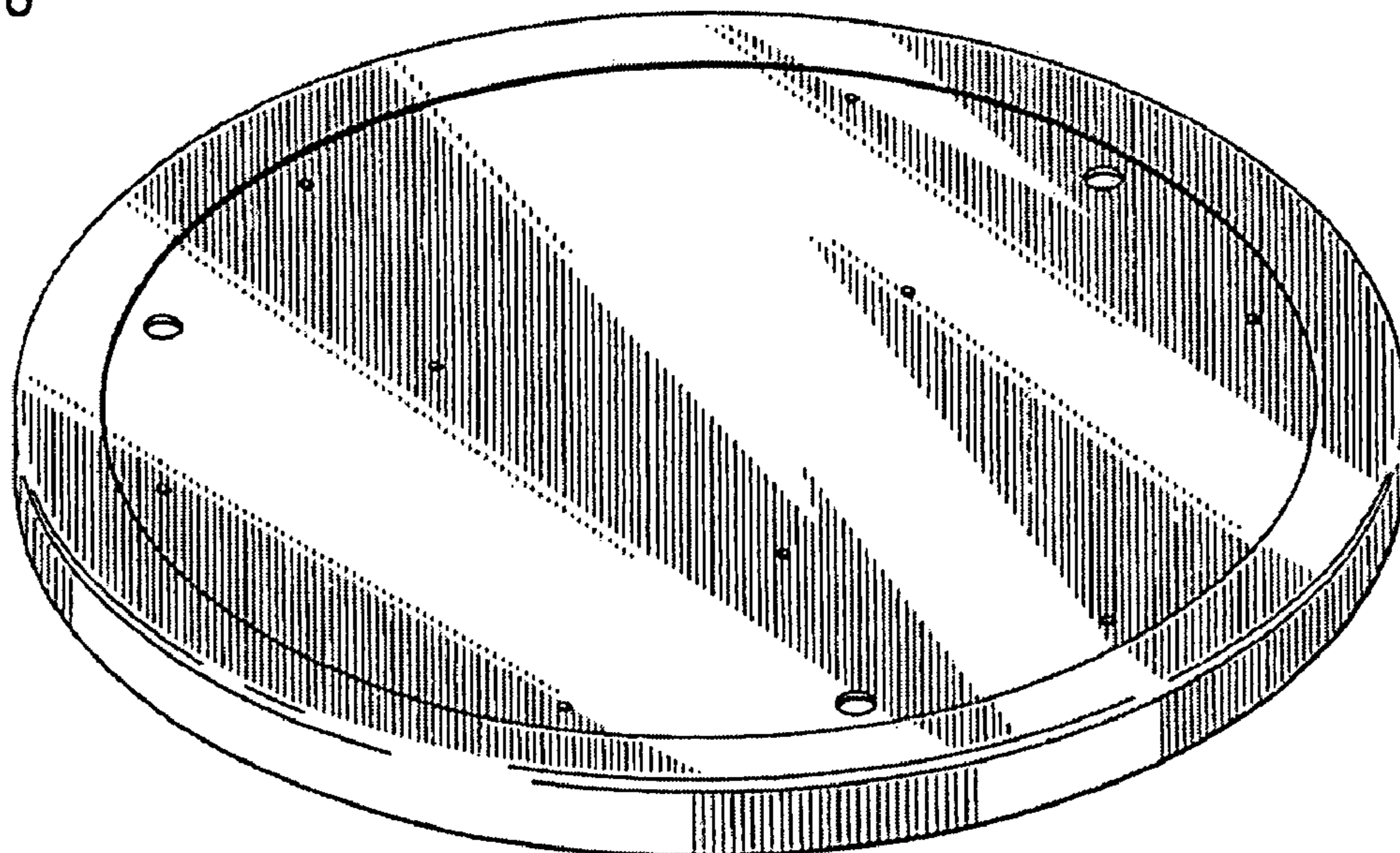


FIG.8



UNITED STATES PATENT AND TRADEMARK OFFICE  
**CERTIFICATE OF CORRECTION**

PATENT NO. : Des. 583,395 S  
APPLICATION NO. : 29/281073  
DATED : December 23, 2008  
INVENTOR(S) : Ueda

Page 1 of 1

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

On the title page, the Terminal Disclaimer information has been omitted. The Notice information and Item (45) should read as follows:

Title Page should read

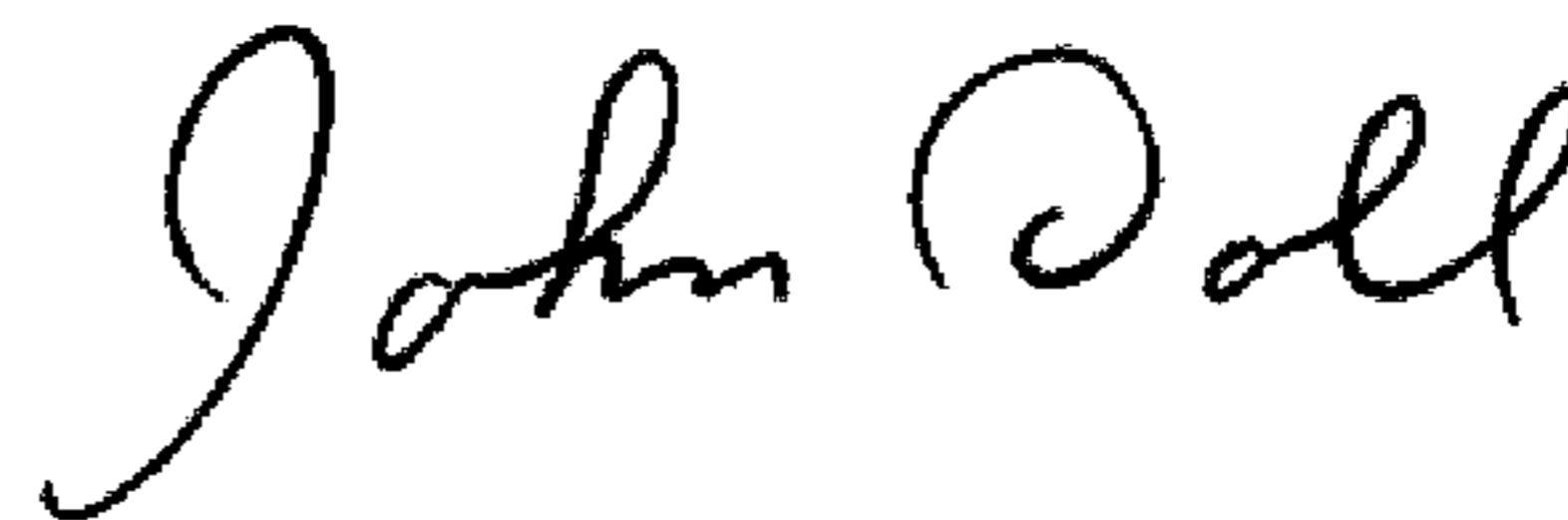
Item (45) **Date of Patent: \*\* \* Dec. 23, 2008**

-- (\*) Notice: This patent is subject to a terminal disclaimer.

(\*\*) Term: 14 Years--

Signed and Sealed this

Thirty-first Day of March, 2009



JOHN DOLL  
*Acting Director of the United States Patent and Trademark Office*